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Response

THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

M. NAGASHIMA

Group Art Unit: 2835

Serial No.: 09/646,906

Examiner: A. Vortman

Filed: October 10, 2000

Docket No. 100806-00001

For: MOUNTING STRUCTURE FOR TEMPERATURE-SENSITIVE FUSE ON CIRCUIT BOARD

RESPONSE UNDER 37 C.F.R. 1.121

Commissioner for Patents

Washington, D.C. 20231

July 26, 2002

Sir:

As a full and complete response to the Official Office Action dated April 29, 2002, please consider the following remarks.

Claims 1 - 4 are being submitted for reconsideration.

Claims 1-4 were rejected under 35 U.S.C. § 103(a) as being unpatentable over Applicant's admitted prior art (AAPA) in view of Saito (EP/0,732,107). In making this rejection, the Examiner asserts that the combination of these references teaches each and every element of the claimed invention. The Examiner also asserts that it would be obvious to one of ordinary skill in the art to combine these two references.

Claim 1 is directed to a mount structure for thermal fuse on a circuit board comprising certain particular structure. The circuit board has one surface where a